Docket Number: 1613370-0019

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I/we hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

ON-WAFER BURN-IN OF SEMICONDUCTOR DEVICES USING THERMAL.

ROLLOVER					
the specification	of which is attache	d hereto unless the following b	ox is checked:		
	al Application Nu	United States Application Nur			
	we hereby state that I/we have reviewed and understand the contents of the above identified pecification, including the claims, as amended by any amendment referred to above.				
I/we acknowledg in 37 CFR § 1.56	e acknowledge the duty to disclose information which is material to patentability as defined 7 CFR § 1.56				
foreign application application which have also identificertificate, or of a	on(s) for patent or in the designated at leased the delow, by check	enefits under 35 U.S.C. § 119(a nventor's certificate, or § 365(a t one country other than the Urking the box, any foreign application having a filing of med.) of any PCT international nited States, listed below and eation for patent or inventor's		
Prior Foreign Ap	plication(s)		Priority Is Claimed		
Number	Country	Day/Month/Year Filed			
Number	Country	Day/Month/Year Filed			
I/we hereby claim application(s) list		35 U.S.C. § 119(e) of any Unit	ed States provisional		
(Application Number)			(Filing Date)		

I/we hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT international application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Number)	(Filing Date)	(Statuspatented, pending, abandoned)
(Application Number)	(Filing Date)	(Statuspatented, pending, abandoned)
	cation identified abov	e, and to transact all business in the ed therewith.
Address all correspondence to Telephone No.: (650) 213-030		
statements made on information statements were made with the punishable by fine or imprison	n and belief are believe knowledge that willfu nent, or both, under Se	f my own knowledge are true and that all to be true; and further that these I false statements and the like so made are ection 1001 of Title 18 of the United States ardize the validity of the application or any
Full name of sole or first inven	tor (first name, middle	initial, last name): Hong Q. Hou
Sole or first inventor's signature	e do do	Date: <u>09/06/02</u>
Residence: 11533 Woodmar La Citizenship: USA	nne, N.E., Albuquerque	e, New Mexico 87111
<u> - : — — </u>	Same as above	·
		
Full name of sole or second inv	entor (first name, mide	dle initial, last name): Charlie X. Wang
Sole or first inventor's signature	Charlenan	e_Date: 9/6/02
Residence: <u>7909 William Moy</u> Citizenship: <u>USA</u> Post Office Address:	ers Avenue N.E., Albu	querque, New Mexico 87122